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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR NP180N04TUG

### SWITCHING N-CHANNEL POWER MOS FET

#### DESCRIPTION

The NP180N04TUG is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### **ORDERING INFORMATION**

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP180N04TUG-E1-AY Note		Таре	TO-263-7pin (MP-25ZT)
NP180N04TUG-E2-AY Note	Pure Sn (Tin)	800 p/reel	typ. 1.5 g

Note Pb-free (This product does not contain Pb in the external electrode).

#### FEATURES

Super low on-state resistance

 $R_{DS(on)}$  = 1.2 m $\Omega$  TYP. / 1.5 m $\Omega$  MAX. (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 90 A)

High Current Rating

 $I_{D(DC)}$  = ±180 A

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	40	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±180	А
Drain Current (pulse) Note1	D(pulse)	±720	А
Total Power Dissipation (Tc = 25°C)	P <sub>T1</sub>	288	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	PT2	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Energy Note2	Eas	518	mJ
Repetitive Avalanche Current Note3	lar	72	А
Repetitive Avalanche Energy Note3	Ear	518	mJ

(TO-263-7pin)



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 20 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V, L = 100  $\mu$ H

**3.** RG = 25  $\Omega$ , Tch(peak)  $\leq$  150°C

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	0.52	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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Document No. D18896EJ1V0DS00 (1st edition) Date Published September 2007 NS Printed in Japan

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1	μA
Gate Leakage Current	lgss	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±100	nA
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	3.0	4.0	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 45 A	51	107		S
Drain to Source On-state Resistance Note	RDS(on)	Vgs = 10 V, Id = 90 A		1.2	1.5	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V,		17100	25700	pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V,		1420	2130	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		890	1610	pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 90 A,		54	120	ns
Rise Time	tr	V <sub>GS</sub> = 10 V,		43	110	ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 0 Ω		104	210	ns
Fall Time	tr			21	60	ns
Total Gate Charge	QG	V <sub>DD</sub> = 32 V,		260	390	nC
Gate to Source Charge	Q <sub>GS</sub>	Vgs = 10 V,		52		nC
Gate to Drain Charge	Qgd	I <sub>D</sub> = 180 A		88		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = 180 A, V <sub>GS</sub> = 0 V		0.9	1.5	V
Reverse Recovery Time	trr	I⊧ = 180 A, V <sub>GS</sub> = 0 V,		65		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		110		nC

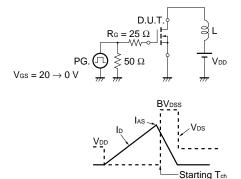
#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

Note Pulsed test

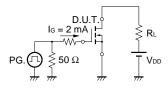
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

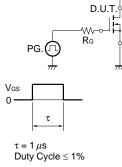
#### **TEST CIRCUIT 2 SWITCHING TIME**

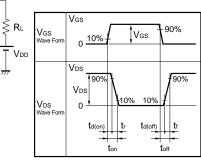
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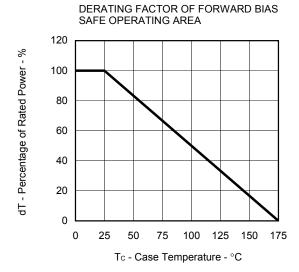
#### TEST CIRCUIT 3 GATE CHARGE



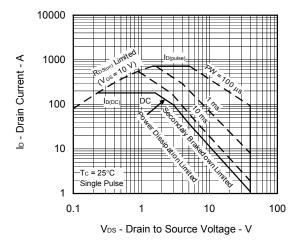


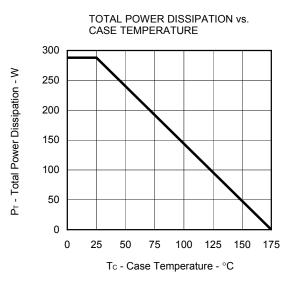


#### TYPICAL CHARACTERISTICS (TA = 25°C)

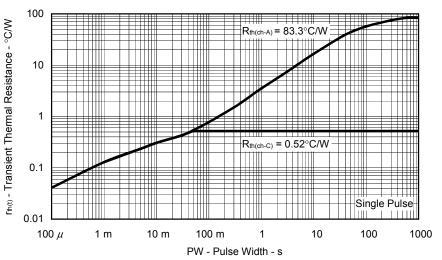




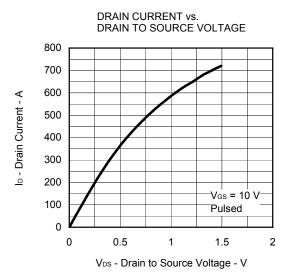




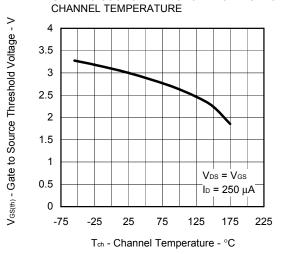
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



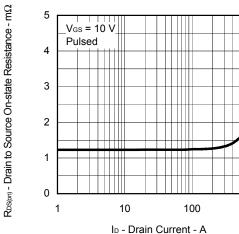
Data Sheet D18896EJ1V0DS



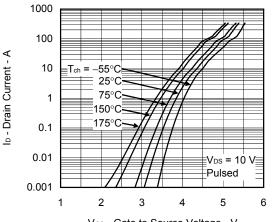




DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

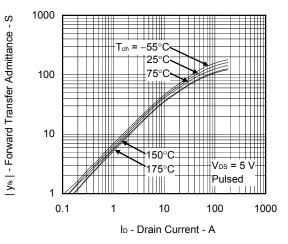


FORWARD TRANSFER CHARACTERISTICS

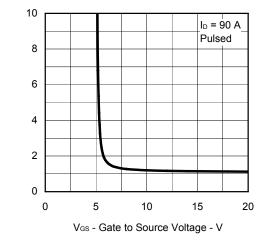


 $V_{\text{GS}}$  - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

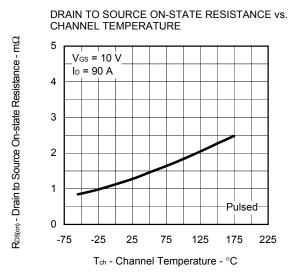


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

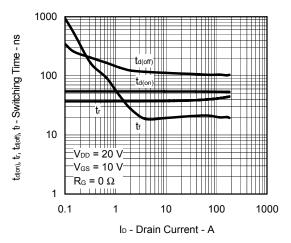


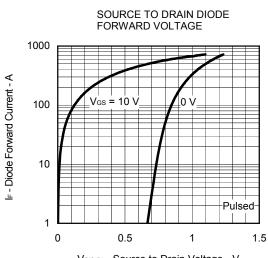
1000

RDS(ON) - Drain to Source On-state Resistance - m0

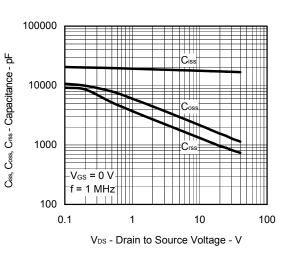






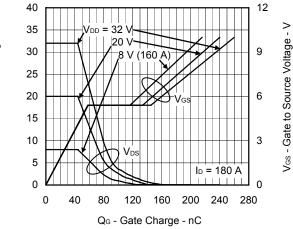


V<sub>F(S-D)</sub> - Source to Drain Voltage - V



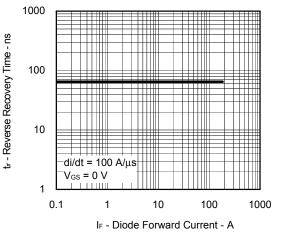
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



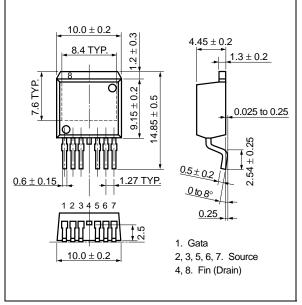
V<sub>DS</sub> - Drain to Source Voltage - V

REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

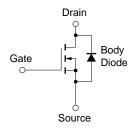


#### PACKAGE DRAWING (Unit: mm)

#### TO-263-7pin (MP-25ZT)



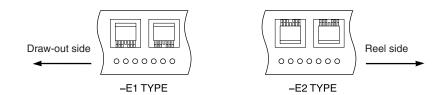
#### EQUIVALENT CIRCUIT



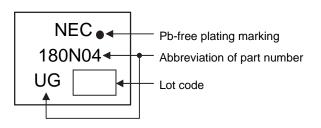
**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

#### TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



#### MARKING INFORMATION



#### **RECOMMENDED SOLDERING CONDITIONS**

The NP180N04TUG should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol	
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below Time at maximum temperature: 10 seconds or less		
	Time of temperature higher than 220°C: 60 seconds or less	IR60-00-3	
	Preheating time at 160 to 180°C: 60 to 120 seconds		
	Maximum number of reflow processes: 3 times Maximum chlorine content of rosin flux (percentage mass): 0.2% or less		
Partial heating	Maximum temperature (Pin temperature): 350°C or below		
	Time (per side of the device): 3 seconds or less	P350	
	Time (per side of the device): 3 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	P350	

Caution Do not use different soldering methods together (except for partial heating).

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